

Vishay Siliconix

COMPLIANT

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY			
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Тур)
150	0.018 at V _{GS} = 10 V	90 ^d	64

TO-220AB

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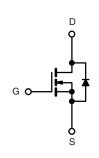
G D S Top View Ordering Information: SUP90N15-18P-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested

APPLICATIONS

- Primary Side Switch
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless othe	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	150	v	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	I	90 ^d	A	
	T _C = 70 °C	D'D	75		
Pulsed Drain Current		I _{DM}	180		
Avalanche Current		I _{AS}	50		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	125	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	Р	375 ^b	w	
	T _A = 25 °C ^c	– P _D –	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.4		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

d. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V$, $I_{D} = 250 \mu A$	150			- V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
Zero Gate Voltage Drain Current		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
	I _{DSS}	V_{DS} = 150 V, V_{GS} = 0 V, T_{J} = 125 °C			50	
		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a	r	V _{GS} = 10 V, I _D = 20 A		0.0145	0.018	Ω
	r _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.029	0.036	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		55		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 75 V, f = 1 MHz		4180		pF
Output Capacitance	C _{oss}			235		
Reverse Transfer Capacitance	C _{rss}			83		
Total Gate Charge ^c	Qg			64	100	nC
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 75 V, V_{GS} = 10 V, I_D = 85 A		23		
Gate-Drain Charge ^c	Q _{gd}			16		
Gate Resistance	Rg	f = 1 MHz		2.1	4.2	Ω
Turn-On Delay Time ^c	t _{d(on)}			15	25	
Rise Time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{DD} = 75 \ V, \ R_L = 0.88 \ \Omega \\ I_D \cong 85 \ A, \ V_GEN = 10 \ V, \ R_g = 1 \ \Omega \end{array}$		10	15	
Turn-Off Delay Time ^c	t _{d(off)}			25	40	- ns
Fall Time ^c	t _f			8	15	
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b				
Continuous Current	ا _S				90	A
Pulsed Current	I _{SM}				180	
Forward Voltage ^a	V _{SD}	$I_F = 30 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	А
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC

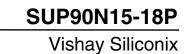
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

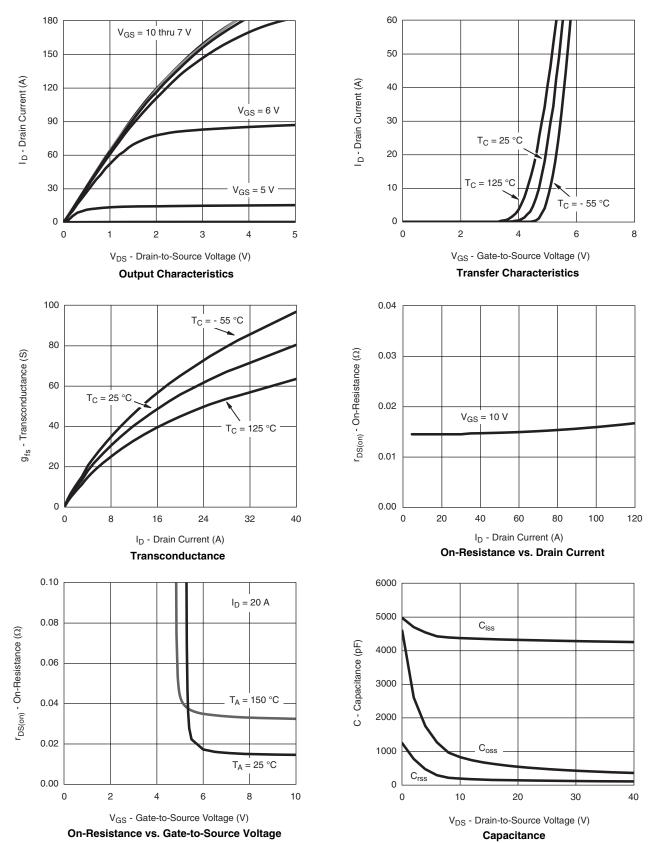
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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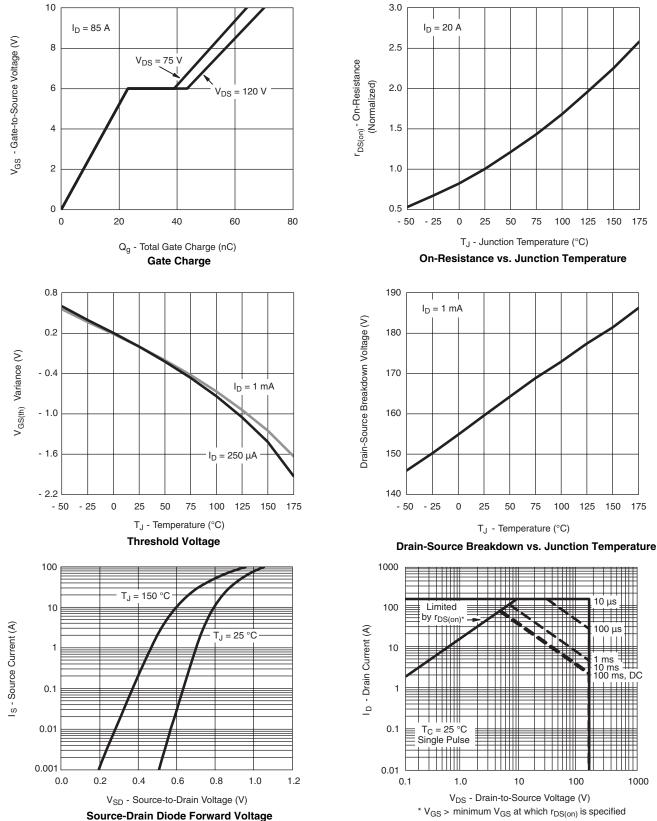


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SUP90N15-18P

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified Safe Operating Area, Junction-to-Case



150 175

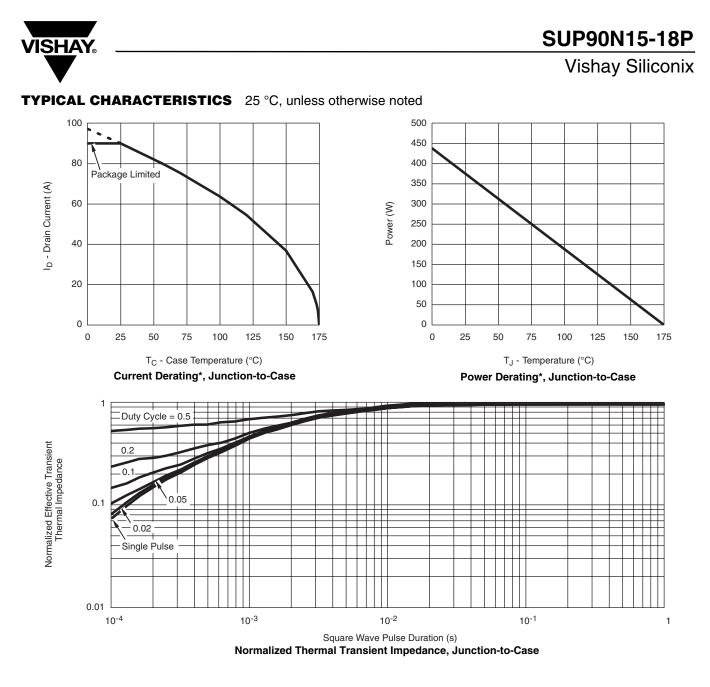
125 150 175

10 µs

100 us

ms ms 100 ms DC

1000



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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